## <sub>设计指南</sub>: TIDA-010024 具有增强型网络容量的安全 6LoWPAN 网状终端节点参考设计

# TEXAS INSTRUMENTS

#### 说明

此参考设计实现了一种带数据传输层加密 (DTLS) 的射频 (RF) 网状网络终端节点,可适用于智能仪表先进抄表基础设施 (AMI) 网络。该网络是一种基于 IPv6 的低功耗无线个人局域网 (6LoWPAN) 解决方案。该设计在单个 CC1312R SimpleLink™无线 MCU 中实现了该网络,从而增强性能并尽可能减少系统成本。整个6LoWPAN 网状网络都在基于 IEEE 802.15.4e/g 协议的TI-15.4 堆栈上运行,且实现了非时隙信道跳跃 (USCH)模式,可防止网络干扰。与包含更大邻居表和路由表的TIDA-010003 终端节点设计相比,网络容量得到提升,安全性得到增强。

夹

夹夹

夹

夹夹

#### 资源

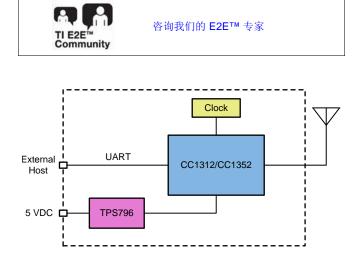
TIDA-010024	设计文件
CC1312R	产品文件
TM4C1294NCPDT	产品文件
LM4040	产品文件
TPS796	产品文件
SN74AVC4T245	产品文件

### 特性

- 基于低功耗射频(在低于 1GHz ISM 频带中运行)的 IPv6 网络
- 实现了 6LoWPAN、RPL、IPv6、ICMPv6、UDP 和 DTLS IP 网状网络协议
- 实现了具有基于 IEEE 802.15.4e 的跳频和 MAC 数据加密功能的 TI-15.4 堆栈
- 与 Wi-SUN FAN v1.0 相同的软件层架构
- 将 DTLS、更大的邻居表和路由表添加到《可提高网络性能的 TIDA-010003 简易 6LoWPAN 网状终端节点参考设计》
- 支持适用于电池供电终端节点的低功耗模式配置

#### 应用

- 无线通信
- 电表
- 水表
- 燃气表







该 TI 参考设计末尾的重要声明表述了授权使用、知识产权问题和其他重要的免责声明和信息。



#### 1 System Description

This reference design provides a low-power RF mesh network end node that supports 6LoWPAN mesh protocols. A primary design goal is to add Datagram Transport Layer Security (DTLS) support plus improve network performance with larger neighbor and routing tables compared to the TIDA-010003 end-node reference design. This designs retains the Frequency Hopping (FH) techniques that increase robustness in noisy Radio Frequency (RF) environments.

FH is a technique of transmitting data by switching one of many channels where the channel is selected by a pseudo-random sequence known to both sender and receiver. This technique is known as robust versus interference and excellent in coexistence performance. 3.2  $\ddagger$  shows experimental results to measure and verify network performance in different scenarios. These scenarios are used to reproduce real life use cases and showcase how the system will perform in these special cases. The testings also show the negligible impact of DTLS on the overall performance. In addition,  $\frac{1}{2}$  summarizes key system performance.

Another segment of this design is the 6LoWPAN mesh stacks, which improves network coverage and supports IPv6-based applications. The increased network coverage reduces the total system cost by reducing the number of data collectors that are typically more expensive than smart meters. The smart meters are static in the Advanced Metering Infrastructure (AMI) networks. The mesh networking addresses the connectivity issue through multi-hop transmissions when data collectors and smart meters are not reachable with each other.

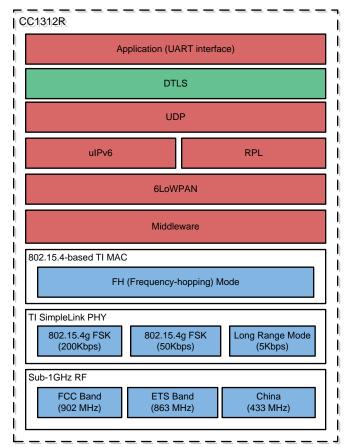
This design is based upon a SimpleLink<sup>™</sup> MCU of the CC13x2 wireless MCU. I shows the overall system architecture. The TI-15.4 Medium Access Control (MAC) supports FH mode. The TI SimpleLink PHY supports 200-kbps and 50-kbps frequency-shift keying (FSK) mode, and 5-kbps long range mode. The sub-1 GHz RF on the CC1312R MCU can support three frequency bands: 902 MHz, 863 MHz, and 433 MHz.

This design is an evolution of the TIDA-010003 Simple 6LoWPAN End-Node Improves Network Performance Reference Design. 表 1 summarizes the key differences in terms of system features between the two reference designs.

	TIDA-010024	TIDA-010003
Wireless MCU	CC1312R	CC1310
Max neighbor entries	100	10
Max route entries	<ul><li> 200 for root node</li><li> 100 for end node</li></ul>	10 for end node
Security	DTLS     IEEE 802.15.4 MAC security	IEEE 802.15.4 MAC security
Max number of hop	64	64
Total flash size	352 KB	128 KB
Remaining flash memory	255 KB (debug_poll CCS configuration)	4 KB
Total RAM size	80 KB (+8 KB Cache)	20 KB (+8 KB Cache)
Remaining RAM	41 KB (debug_poll CCS configuration)	5 KB

#### ${\it ${\bar{\pi}}$}$ 1. System Features of TIDA-010024 and TIDA-010003





#### 图 1. TIDA-010024 System Architecture



### 1.1 Key System Specifications

PARAMETER	SPECIFICATIONS	DETAILS
Maximum number of hops	<ul><li>64 hops (in software, configurable)</li><li>Tested up to 6-hop networks</li></ul>	
Maximum number of route entries	<ul><li> 200 for root node</li><li> 100 for end node</li><li> Tested up to 100-node networks</li></ul>	
Maximum number of neighbor nodes	<ul><li>100 for end node and route node</li><li>Tested up to 100-node networks</li></ul>	
Maximum application data size	<ul><li> 200 B (in software, configurable)</li><li> Tested up to 200 B</li></ul>	
Delivery ratio	<ul><li>99.42% (average in 6-hop linear topology with DTLS)</li><li>97.14 % (average with 100 nodes network)</li></ul>	
Round-trip time (RTT)	<ul><li>0.445 second (100B over 1-hop node with DTLS)</li><li>2.29 second (100B over 6-hop node with DTLS)</li></ul>	
MAC data encryption	<ul> <li>IEEE 802.15.4-based encryption supported</li> <li>MIC-32, MIC-64, MIC-128</li> <li>ENC, ENC-MIC-32, ENC-MIC-64, and ENC-MIC-128</li> </ul>	节 3.1.2.2.1.3
DTLS encryption	DTLS v1.2     MAC-level DTLS	The MAC-level DTLS was activated and verified in this design.
Memory usage	<ul> <li>End node (debug_poll configuration): <ul> <li>Flash: 255 KB free</li> <li>RAM: 41 KB free</li> </ul> </li> <li>Root node (debug_root_poll configuration): <ul> <li>Flash: 248 KB free</li> <li>RAM: 34 KB free</li> </ul> </li> </ul>	

### 表 2. Key System Specifications

#### System Overview

#### 2 System Overview

#### 2.1 Block Diagram

2 shows the system block diagram. The CC1312R (or CC1352R) MCU is the 6LoWPAN mesh MCU that runs UDP applications, 6LoWPAN mesh network, and the TI 15.4-Stack over sub-1 GHz RF.

The external DC/DC converter, as shown in 2 2, is needed when the external power source supplies the voltage level other than 3.3 V. In this reference design, because the evaluation modules (EVMs) are powered by USB, the TPS796 was chosen to convert 5 V to 3.3 V.

For end-equipment designs, the selection of the power supply depends on the input/output voltage level and required current consumption. The TI WEBENCH Power Designer provides the detailed design of the power supply with the given input requirements.

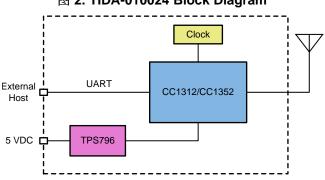


图 2. TIDA-010024 Block Diagram

#### 2.2 **Design Considerations**

For this reference design, these devices perform the following:

- The CC1312R wireless MCU combines an Arm® Cortex®-M3 MCU with a flexible, ultra-low-power RF ٠ transceiver with excellent RX sensitivity to provide a robust link budget and execute the TI 15.4-Stack.
- The TPS796 low-power linear regulator offers high power-supply rejection ratio (PSRR), ultra-low noise, fast start-up, and excellent line and load transient responses.

#### 2.3 **Highlighted Products**

#### 2.3.1 CC1312R

The CC1312R wireless MCU is a member of the SimpleLink MCU platform. Its very low current consumption in both active and standby mode provides excellent lifetime when operating from batteries or super capacitors.

The CC1312R combines a flexible, very low-power RF transceiver with a powerful 48-MHz Cortex-M3 MCU in a platform supporting multiple physical layers and RF standards. A dedicated radio controller (Cortex-M0) handles low-level RF protocol commands that are stored in ROM or RAM, thus ensuring ultralow power and flexibility. Its RF subsystem offers an excellent link budget with receiver sensitivity with -110 dBm at 50 kbps and output power up to +14 dBm. The CC1312R is a highly integrated, true single-



System Overview

www.ti.com.cn

chip solution incorporating a complete RF system and an on-chip DC/DC converter. The CC1312R wireless MCU is supported by the SimpleLink Software Development Kit (SDK) that offers 100% application code compatibility across the entire SimpleLink MCU portfolio and includes the integrated TI-RTOS, complete peripheral driver libraries with POSIX-compatible APIs, and encryption-enabled security features.



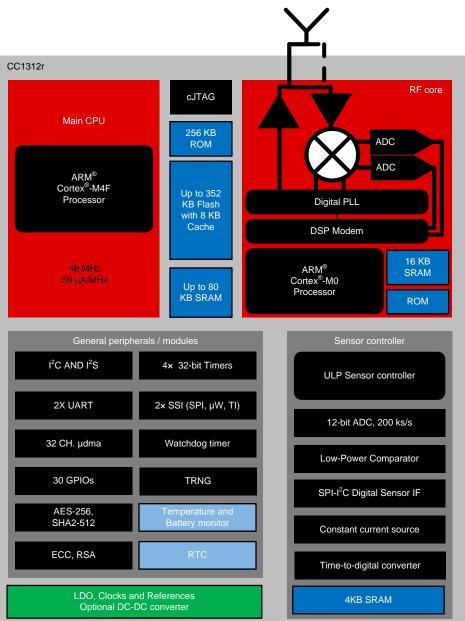


图 3. CC1312R Functional Block Diagram



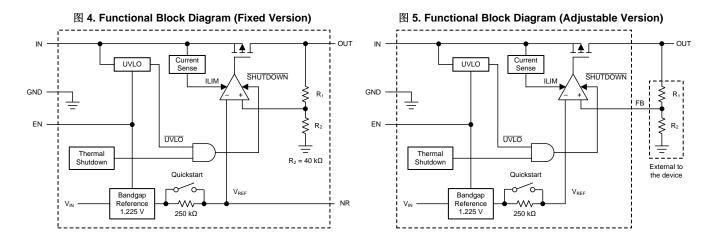
#### System Overview

#### 2.3.2 TPS796

The TPS796 family of low-dropout (LDO), low-power linear voltage regulators feature high power-supply rejection ratio (PSRR), ultra-low noise, fast start-up, and excellent line and load transient responses in small outline,  $3\times3$  VSON, SOT223-6, and TO-263 packages. Each device in the family is stable with a small, 1-µF ceramic capacitor on the output. The family uses an advanced, proprietary BiCMOS fabrication process to yield extremely LDO voltages (for example, 250 mV at 1 A).

Each device achieves fast start-up times (approximately 50  $\mu$ s with a 0.001- $\mu$ F bypass capacitor) while consuming very low quiescent current (265  $\mu$ A, typical). Moreover, when the device is placed in standby mode, the supply current is reduced to less than 1  $\mu$ A. The TPS79630 exhibits approximately 40  $\mu$ V<sub>RMS</sub> of output voltage noise at 3.0-V output with a 0.1- $\mu$ F bypass capacitor. Applications with analog components that are noise sensitive, such as portable RF electronics, benefit from the high PSRR, low-noise features, and fast response time.

图 4 and 图 5 show the TPS796 functional block diagrams.





#### 3 Hardware, Software, Testing Requirements, and Test Results

#### 3.1 Required Hardware and Software

#### 3.1.1 Hardware

This reference design is built with a standard TI EVM of LAUNCHXL-CC1312, as shown in 图 6.

图 6. TIDA-010024 Hardware Platform





#### 3.1.2 Software

#### 3.1.2.1 Getting Started

The 6LoWPAN mesh software examples were implemented based on the TI-15.4 sensor example from SimpleLink<sup>™</sup> CC13x2 and CC26x2 SDK v2.40. The software examples provided with the reference design run on the CC1312R MCU to support 6LoWPAN, RPL routing, IPv6, ICMPv6, UDP, DTLS and simple applications. The pre-requisite tools to build the software example are Code Composer Studio<sup>™</sup> v8.0 or above (CCSTUDIO) and SimpleLink<sup>™</sup> CC13x2 and CC26x2 SDK v2.40 (SIMPLELINK-CC13X2-26X2-SDK).

 $\frac{1}{8}$  3 shows the summary of software example with CCS build configuration options.

BUILD CONFIGURATION	EXAMPLE	ROLE	DATA ENCRYPTION
debug_poll	UDP Poll	End node	IEEE 802.15.4 MAC encryption
debug_push	UDP Push	End node	IEEE 802.15.4 MAC encryption
debug_poll_dtls	UDP Poll	End node	MAC-level DTLS +IEEE 802.15.4 MAC encryption
debug_poll_demo	UDP Poll	End node (demo with TIDA- 010032)	IEEE 802.15.4 MAC encryption
debug_push_leaf	UDP Push	End node (Low-power mode)	IEEE 802.15.4 MAC encryption
debug_root_poll	UDP Poll	Root node	IEEE 802.15.4 MAC encryption
debug_root_push	UDP Push	Root node	IEEE 802.15.4 MAC encryption
debug_root_poll_dtls	UDP Poll	Root node	MAC-level DTLS + IEEE 802.15.4 MAC encryption

#### 表 3. CCS Build Configurations

For the UDP poll example, end nodes send UDP data only when they receive the poll message from the root node. This example is popular in dense networks because this approach can control network traffic effectively regardless of the network size with the cost of polling overheads. For the UDP push example, end nodes send UDP data whenever they have data to send. Compared to the UDP poll-based approach, this technique reduces the polling overhead while it increases collision probability among transmissions of the end nodes in a dense network.

The UDP poll and push examples improve the level of security with the DTLS data encryption. The debug\_poll\_dtls build configuration provides an example of UDP poll example with the DTLS encryption. They will work the exact same way in terms of mesh stacks as UDP poll and push examples but with additional MAC-level DTLS encryption.

This design also allows the CC13x2 to be used as the root node. The root node in the UDP poll mode requests data from the nodes and sends the statistics of delivery ratio and round trip time (RTT) through a serial terminal. In the UDP push mode, the root node receives the data from the connected nodes in the network and sends the statistics through a serial terminal.

The leaf node configuration (debug\_push\_leaf) was designed to provide a low power operation mode for battery-operated devices. To achieve low power consumption, this mode disables routing capability, turns RX off when idle and runs on top of the TI 15.4-Stack sleep mode. An advantage is to extend end-nodes' coverage with the built-in mesh network while keeping power consumption low. A use case will be battery-powered flow meters or in-home display connected to an electricity meter acting as a router node.

 $\pm$  4 summarizes node configurations supported by this design.



Hardware, Software, Testing Requirements, and Test Results

#### 表 4. Node Configurations

Feature	ROOT	INTERMEDIATE	LEAF
Router Capability	Yes	Yes	No
RX ON when Idle	Yes	Yes	No
TI 15.4-Stack	FH non-sleep mode	FH non-sleep mode	FH sleep mode
Build Configuration	<ul><li> debug_root_poll</li><li> debug_root_push</li><li> debug_root_poll_dtls</li></ul>	<ul> <li>debug_poll</li> <li>debug_push</li> <li>debug_poll_dtls</li> <li>debug_poll</li> </ul>	debug_push_leaf

The TIDA-01547, TIDA-010003, and TIDA-010032 are companion reference designs that work with this design. These designs provide multiple options in terms of system performance or cost to build a complete 6LoWPAN mesh network solution.

Properties for 6lowpan_mesh_ti_	5_4_cc1312_tirtos_ccs	tastforms,		
type filter text	General			⇔ - ⇔ -
> Resource				
General			. ار	
⊿ Build	Configuration: debug_poll [ Act	tive ]	▼.	Manage Configurations
> XDC tools				
▲ ARM Compiler	👕 Project 🛋 Products			
Processor Options	Products			
Optimization	Device			
Include Options ULP Advisor	Family: ARM			•
OLP Advisor Predefined Symbols	Variant <select fil<="" or="" td="" type=""><td>ter text&gt;</td><td>CC1312R1F3</td><td></td></select>	ter text>	CC1312R1F3	
> Advanced Options				
> ARM Linker	Connection: Texas Instruments	XDS110 USB Debug Probe [Default]	Verify (applies to whole project	)
ARM Hex Utility [Disablec	Manage the pro	oject's target-configuration automatically		
Debug	Tool-chain			
		3.1.1LTS		▼ More
		.1.1.115		• More
	Output type: RTSC	Application (Executable)		•
	Output form at eabi (	(ELF)		•
	Device endianness: little			•
	Linker command file: cc13	<2lp.cmd		Browse
		•		
	Runtime support library:			▼ Browse
∢				
Show advanced settings			Apply and	Close Cancel
			Apply and	Cancel

### 图 7. Code Composer Studio™ Compiler Version



Properties for 6lowpan_mesh_ti	15_4_cc1312_tirtos_ccs	
type filter text	General $\diamond$ $\checkmark$ $\diamond$ $\checkmark$	
<ul> <li>&gt; Resource</li> <li>General</li> <li> <ul> <li>Build</li> <li>&gt; XDC tools</li> <li>ARM Compiler</li> <li>Processor Options</li> </ul> </li> </ul>	Configuration: debug_poll [Active]   Manage Configurations  Project Project Products	
Optimization Include Options ULP Advisor Predefined Symbols > Advanced Options > ARM Linker ARM Hex Utility [Disablec Debug	XDCtools version:       3.51.118_core         Add       >         BasimpleLink CC13x0 SDK       >         Select All       >         Deselect All       >         Deselect All       >	
Show advanced settings	Target       ti.targets.arm.elf.M4F         Platform:       ti.platform s.simplelink:CC1312R1F3         Build-profile:       release	

图 8. Code Composer Studio<sup>™</sup> XDC Tool and SDK Versions

To implement the 6LoWPAN mesh design on the CC1352R wireless MCU, the same changes can be made with the CC1352R TI-15.4 sensor example from SimpleLink<sup>™</sup> CC13x2 and CC26x2 SDK v2.40. The step-by-step procedure is given below:

- 1. Import CC1352R TI-15.4 sensor example from SimpleLink™ CC13x2 and CC26x2 SDK v2.40
- 2. Rename CCS project with your project
- 3. Copy and paste the entire directories of 6lowpan, Application and dtls into the project directory of the CC1352R TI-15.4 sensor example
- 4. Overwrite app.cfg, cc13x2lp.cmd and ccfg.c
- 5. Create build configurations and update the CCS property (Predefined symbols and Include options) based on the CC1312R-based 6LoWPAN mesh example project

#### 3.1.2.2 6LoWPAN Mesh TI 15.4 Example

This section starts with a software overview followed by details of the software architecture and useful tips for debugging and optimizing the software.

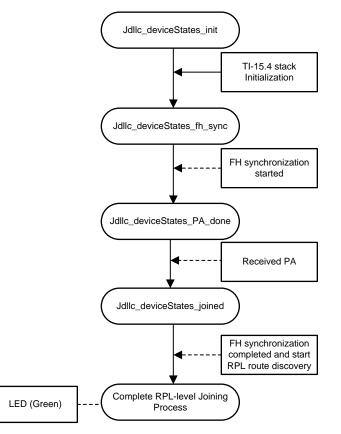
注: This reference design provides an open-source based working example that can be a baseline software to develop end-products. The software example is not optimized in RAM or Flash usage and does not guarantee product-level quality.

#### 3.1.2.2.1 Example Overview

This reference design implements a 6LoWPAN mesh network system working with the FH MAC over sub-1 GHz RF. The 6LoWPAN mesh network stacks run on TI-RTOS, which are implemented based on CONTIKI open source.

8 9 shows the end-node example software state machine. After power on, the end node starts with the *Jdllc\_deviceStates\_init* state and, after completing the initialization, goes to the

*Jdllc\_deviceStates\_fh\_sync* state where the node starts FH synchronization, which consists of two steps, discussed in  $\ddagger$  3.1.2.2.1.1. Once the node completes the first step of the FH synchronization, the state moves to the *Jdllc\_deviceStates\_PA\_done* state. After the end node completes the FH synchronization, it moves to the *Jdllc\_deviceStates\_joined* state, which is a ready state to start RPL route discovery. The green LED (DIO7) on the EVM indicates that the node has completed the RPL-level joining process. The state machine transition has been implemented in /Application/middleware.c.



#### 图 9. Software State Machine

#### 3.1.2.2.1.1 FH Synchronization

FH synchronization is required to discover the FH network and to synchronize the FH timing and schedule. The underlying TI 15.4-Stack adopts WI-SUN FAN v1.0-based mechanism using four command frames:

- PAN advertisement (PA)
- PAN advertisement solicit (PAS)
- PAN configuration (PC)
- PAN configuration solicit (PCS)

FH synchronization starts with discovering neighbors, or candidates of tracking parents, by performing active scan. The end nodes start with sending PAS commands at the time chosen by the trickle algorithm (RFC 6206). The PAS is sent over all the FH channels from the lowest channel number to the highest in sequence as the nodes do not know the FH timing and schedule at this time. As a response to the PAS, the PA is sent by the nodes that has already joined to the FH network. When the end nodes receive multiple PAs during the scan period (SCAN\_TIMEOUT\_VALUE), one will be chosen based on the link-level metric and then update unicast FH timing, schedule, and the PAN information with the tracking FH parent.

The next step is to send the PCS in the same way as the PAS. Once the nodes receive the PC as a response, they update the broadcast FH timing and schedule and the Group Transient Key (GTK) hash information. Receiving PC as a response of the PCS completes the FH synchronization process, which is ready to receive and send data at the network layers.

The FH timing and schedule correction is done with the received data packets that contain FH unicast and broadcast timing and schedule information elements (IEs).

注: The FH synchronization mechanism implemented in this reference design is TI proprietary and is not WI-SUN FAN standard compliant.

表 5 summarizes the trickle algorithm parameters used for FH synchronization. Depending on the network size, the parameters may need to be adjusted. These parameters are defined in /Application/middleware.h.

PARAMETER	VALUE	DESCRIPTION
TRICKLE_TIMEOUT_VALUE	6 seconds	Discovery trickle timer minimum timeout for PAS and PCS
TRICKLE_MAX_BACKOFF	3	Discovery trickle timer backoff exponent for PAS and PCS
SCAN_TIMEOUT_VALUE	20 seconds	Discovery trickle timer timeout for PA and PC

表 5. Trickle Algorithm Parameters

### 3.1.2.2.1.2 Keep-Alive Mechanism

The goal of the keep-alive mechanism is to detect FH sync loss throughout monitoring sync error conditions such as data transmission and reception failures. The keep-alive mechanism broadcasts keep-alive frames (a 10B TI proprietary message defined in the example) to the link-level neighbors periodically (KEEP\_ALIVE\_TX\_TIMEOUT\_VALUE) once end nodes join to the FH network. The keep-alive TX timer is reset when broadcast frames other than keep-alive frames are sent, which reduces the keep-alive traffic overheads to the network.

If end nodes do not receive broadcast frames from their tracking parents in series (KEEP\_ALIVE\_MAX\_ATTEMPTS), FH sync loss occurs and the end nodes move immediately to the *Jdllc\_deviceStates\_fh\_sync* state to restart the FH synchronization process.

In addition to the keep-alive transmissions, each node traces unicast transmission failures to the target parents. If TX attempts fail in series (MAXIMUM\_NUM\_DATA\_FAILURE), this indicates the FH sync loss, which results in moving to the *Jdllc\_deviceStates\_fh\_sync* state to re-start the FH synchronization process. 表 6 summarizes the keep-alive parameters. The keep-alive parameters are defined in /Application/middleware.h.

PARAMETER	VALUE	DESCRIPTION
KEEP_ALIVE_TX_TIMEOUT_VALUE	60 seconds	Keep-alive TX interval for parents
KEEP_ALIVE_MAX_ATTEMPTS	5 times	The maximum number of failed keep-alive RX in series to indicate FH sync loss
MAXIMUM_NUM_DATA_FAILURE	5 packets	The maximum number of TX failure to indicate FH sync loss

表 6.	Keep-Alive	Parameters
------	------------	------------

#### 3.1.2.2.1.3 MAC Data Encryption

The MAC data encryption follows IEEE 802.15.4 standard with the security level options of MIC-32, MIC-64, MIC-128, ENC, ENC-MIC- 32, ENC-MIC-64 and ENC-MIC-128.

In the software example, the default mode is set to the security level of *ApiMac\_secLevel\_encMic32* and the key ID mode of *ApiMac\_keyIdMode\_8*, defined in the /Application/jdllc\_middleware.c. The TI 15.4-Stack supports the pre-shared key mechanism based on IEEE 802.15.4 standard. The security key should be pre-programmed in the software, and all of the nodes in the same network must share the same pre-shared key.

Because the MAC data encryption mechanism requires a node to register its neighbors that use the data encryption, it is required to have a discovery phase throughout unsecured data exchanges. The PAS and PA frames used for the FH synchronization must be sent without data encryption. In addition, the software example uses unsecured transmissions for PC, PCS, and broadcast frames to minimize a chance that some neighbors with a better route are not detected during the discovery phase.

#### 3.1.2.2.1.4 DTLS Encryption

This software example uses the tinyDTLS library for the DTLS. The current version of tinyDTLS supports DTLSv1.2 with SHA256. DTLS v1.2 is based on TLS 1.2 and runs over UDP to provide end-to-end secured transport.

This design implements a TI proprietary MAC-level DTLS mechanism. This consists of using the MAC encryption mechanism with the private key generated by DTLS that runs on application and negotiating the key with a two-way handshake mechanism. The negotiation process is performed between link-level neighbors and thus each pair of neighbors shares a different private key.



The 6LoWPAN mesh software example uses the RPL protocol for multi-hop routing. The network formation with the RPL routing is initiated by broadcasting Destination Oriented Directed Acyclic Graph (DODAG) information object (DIO) by the root node. Once child nodes receive the DIOs, they broadcast the DIOs and send back a unicast destination advertisement object (DAO) packet to the parents that provide the best route toward the root. The DIO and DAO transmission times are determined by the trickle algorithm (RFC 6206). For the RPL metric to decide the best route, the expected transmission count (ETX) is used by default. For details on RPL routing, see the RFC standard RFC 6550 or the TI training video on Wireless Network Challenges and Solutions for a Smarter Grid IoT.

#### 3.1.2.2.1.6 6LoWPAN

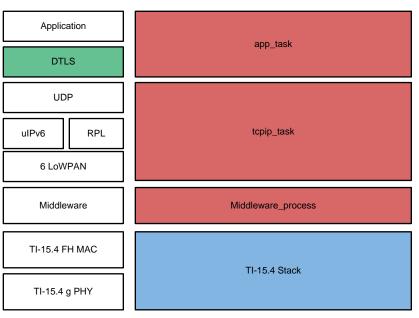
The goal of the 6LoWPAN protocol is to support the IP services by reducing the gap between IPv6 and lower stacks to serve IPv6 applications on the low-end devices typically restricted in processing power, memory, and energy. The primary tasks of the 6LoWPAN are fragmentation and reassembly, IPv6 and UDP header compression, stateless IPv6 address auto-configuration, and neighbor discovery optimization. For details of the 6LoWPAN protocol, see the RFC standards RFC 4944 and RFC 6282 or the TI training video on Wireless Network Challenges and Solutions for a Smarter Grid IoT.

#### 3.1.2.2.2 Software Architecture

The 6LoWPAN mesh end-node software consists of TI 15.4-Stack, middleware layer interconnecting between the TI 15.4-Stack and upper layers of 6LoWPAN mesh stacks and the application layer. The middleware layer initializes and configures the TI 15.4-Stack and processes incoming data from the TI 15.4-Stack or mesh network stacks. The 6LoWPAN mesh stacks cover 6LoWPAN, RPL, IPv6/ICMPv6 and UDP protocols. The software example provides two types of UDP applications that can be configured at compile time: UDP poll and push examples.

This design also implements DTLS data encryption. A simplified two-way DTLS handshake mechanism (MAC-level DTLS) is implemented to minimize the transaction overhead on network performance.

I 0 shows the overall software architecture. The software example was implemented based on the sensor\_cc1312r1lp example available in the SimpleLink<sup>™</sup> CC13x2 and CC26x2 SDK v2.40. The middleware layer runs the middleware\_process that manages the FH synchronization and keep-alive mechanism, and interfaces between TI 15.4-Stack and mesh network stacks to handle incoming data. The middleware layer follows the same software architecture using the iCall service defined in the sensor\_cc1312r1lp example. The tcpip\_task covers the mesh network layers of 6LoWPAN, uIPv6, RPL and UDP layers. If a build configuration using DTLS, the encryption/decryption layer will be added between the UDP and the application layer. The UDP poll and push examples are parts of the app\_task as the application layer.



#### 图 10. TIDA-010024 Software Architecture

#### 3.1.2.2.2.1 TI-15.4 PHY Configuration

The TI 15.4-Stack supports multiple options for the frequency band and mode to run the FH mode. The software example configures the PHY mode to APIMAC\_STD\_US\_915\_PHY\_1. The default configuration can be updated in the /Application/subg/config.h. The following codes list all the options for the PHY ID, which can be found in /Application/api\_mac.h.

注: The TI design software example was verified with the FH operation over the PHY mode of APIMAC\_STD\_US\_915\_PHY\_1.

```
/*! PHY IDs - 915MHz US Frequency band operating mode \# 1 */
#define APIMAC_STD_US_915_PHY_1 1
/*! 863MHz ETSI Frequency band operating mode #1 */
#define APIMAC_STD_ETSI_863_PHY_3 3
/*! 433MHz China Frequency band operating mode #1 */
#define APIMAC_GENERIC_CHINA_433_PHY_128 128
/*! PHY IDs - 915MHz LRM US Frequency band operating mode # 1 */
#define APIMAC_GENERIC_US_LRM_915_PHY_129 129
/*! 433MHz China LRM Frequency band operating mode #1 */
#define APIMAC_GENERIC_CHINA_LRM_433_PHY_130 130
/*! 863MHz ETSI LRM Frequency band operating mode #1 */
#define APIMAC_GENERIC_ETSI_LRM_863_PHY_131 131
/*! PHY IDs - 915MHz US Frequency band operating mode # 3 */
#define APIMAC_GENERIC_US_915_PHY_132 132
/*! 863MHz ETSI Frequency band operating mode #2 */
#define APIMAC_GENERIC_ETSI_863_PHY_133 133
```

#### 3.1.2.2.2.2 Middleware Layer

The middleware layer initializes the TI 15.4-Stack, maintains MAC-level keep-alive mechanism, registers security entries to the TI 15.4-Stack, processes packets incoming from the TI 15.4-Stack or upper layers, handles message timeout and erroneous transmissions, performs FH synchronization and maintains the state machine which can be one of four states: *Jdllc\_deviceStates\_init*, *Jdllc\_deviceStates\_fh\_sync*, *Jdllc\_deviceStates\_PA\_done*, and *Jdllc\_deviceStates\_joined*.



Anend-node starts with the *Jdllc\_deviceStates\_init* state to reset the TI 15.4-Stack to configure initial MAC PIB and FH PIB values and to start the PAN as end node. The state changes to the *Jdllc\_deviceStates\_fh\_sync* state when the node initiates the FH synchronization process. As the first step of the FH synchronization, if the node receives PA as a response of the PAS command, it moves to the *Jdllc\_deviceStates\_PA\_done* state and proceeds to send the PCS command. After the FH synchronization completes by receiving PC commands, the node moves to the *Jdllc\_deviceStates\_joined* state, which is the ready state to send data at the mesh network layers.

Similar to the sensor\_cc1312r1lp example, the communications between TI 15.4-Stack and the middleware is done through iCall messages. Conversely, the message exchanges between the mesh network stacks and the middleware layer are done through mailbox posting or direct MAC API calls. For the details on the iCall framework, refer to ti-15.4-stack-users-guide in docs/ti154stack under the installation directory of SimpleLink<sup>™</sup> CC13x2 and CC26x2 SDK v2.40.

#### 3.1.2.2.2.3 Network Layers (6LoWPAN, IPv6, RPL, and UDP)

The network stacks are implemented based on the CONTIKI open source. The tcpip\_task (in 6lowpan/uip\_rpl\_task.c) processes messages incoming from the application and lower layers through the mailbox. For details of the implementations, refer to the CONTIKI open source website.

#### 3.1.2.2.2.4 DTLS Layer

The DTLS layer is used for the data encryption between the UDP layer and the Application layer. This layer is based on the tinyDTLS library. Two version of DTLS were implemented in the software : DTLS v1.2 and MAC-Level DTLS.

The MAC-level DTLS is the mechanism implemented in the software example. With the MAC-level DTLS, a node starts with the pre-shared key encryption based on IEEE 802.15.4 MAC encryption and then MAC-level DTLS handshake negotiates the private key with its neighbor. Once the handshake completes, the node encrypts data with the private key instead of the pre-shared key.

#### 3.1.2.2.2.5 Application Layer

The example includes two types of UDP applications: UDP poll and UDP push. The app\_task opens the UDP socket (UDP client for the end-node) with known port numbers and starts UDP data transmissions. Depending on the UDP examples, the initiator of the UDP data is different. For the UDP poll example, the root node initiates the poll message to each node to read data. For the UDP push example, each node initiates data transmissions whenever there is application data to send.

The Device Language Message Specification (DLMS) and Companion Specification for Energy Metering (COSEM) for smart metering applications use the poll-based mechanism, and the Constraint Application Protocol (CoAP) uses the mix of UDP poll (GET command) and push (periodic OBSERVE command) mechanisms. The target end-product applications can be easily integrated on top of the given UDP application.

#### 3.1.2.2.2.6 LED Configuration

表 7 summarizes the LED configuration in the software example. The board\_led\_type\_LED1 toggles when transmission or reception events happen. The board\_led\_type\_LED2 turns on when end nodes join to the RPL network.

Hardware, Software, Testing Requirements, and Test Results

#### 表 7. LED Configuration (CC1312R)

NAME (PIN NUMBER)	EVENT	ACTION
board_led_type_LED1 (DIO6)	Data TX/RX	TOGGLE (Red)
board_led_type_LED2 (DIO7)	Complete RPL-level Joining	ON (Green)

#### 3.1.2.2.3 Tips for Debugging and Optimization

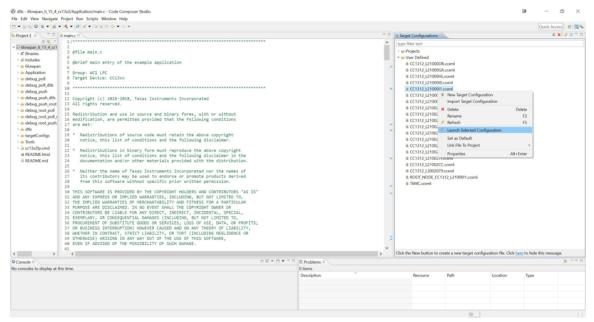
This section provides useful tips with the Code Composer Studio tool to debug and optimize the software example in the end-product development phase.

#### 3.1.2.2.3.1 Running in Debug Mode

To debug software, run the software in debug mode. The Code Composer Studio tool provides the debug mode operation. To run in debug mode with the Code Composer Studio tool:

- 1. Launch the target configuration for the target device as shown in 图 11.
- 2. Connect the target EVM, load the program, and then run the software as shown in 🛽 12.
- 3. Add global variables to debug in the *Expressions* tab as shown in the right top of 🛽 12 to trace the variables in the debug mode.

#### 图 11. Code Composer Studio™ Debug: Launching Debug Window





1 ■ 0 0 ≥ 8 = X > X = X = X = 0 0 € = 0 0 € = 6 = 10 0 € = 10 0 0 € = 10 0 € = 10 0 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 € = 10 0 0 € = 10 0 0 0 € = 10 0 0 € = 10 0 0 0 0 € = 10 0 0 € = 10 0 0 0 0 0 € = 10 0 0 € = 10 0 0 0 0 0 € = 10 0 0 0 0 0 0 € = 10 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	•			Quick Access 🛛 🕫 🕅
Debug II	1 = = = → Variables ≪ Expressions = = Registre	83		신國티수유後관(11년) 수 **
= # C(111)_[21003Hicronif[Code Compose States : Device Detrogoing] (# Teas Intervenets 2003H0108D Debug Protect@Codes_M4.9 Nurreng)	Expression	Type struct <unnamed> struct_topip_debug struct_cunnamed&gt;</unnamed>	Value (ortFlandZeno=0 'u00'.kaPaTimeOut=2 'u02'.ortGlPoInt (httpip_tmout_ont=0.topip_tmout_post_en=0.topip_input_ (httpic_tmout_ont=3360.buf_fuil_drop_segment=0.teg_n_h	0x20003280
	> devinfoBlock > de macPib > de FHPIB_db	struct «unnamed» struct «unnamed» struct «unnamed»	(panID=4660.coordExtAddr=(193 'uc1'.87 'W.168 'ua8'. (ackWaitDuration=54 '6'.associationPermit=0 'u00'.auto. (macTrackParentEUT=(202 'uca',114 'Y.168 'ua8'.24 'ux18.	0x20001A90 0x200029D0
	⇒ joinedDODAG > dB ApiMac_extAdde ♦ Add new expression	unsigned char unsigned char[8]	1 \u01' [5 \u05';223 \w8',154 \u9a';24 \u18',0 \u00']	0x20003228 0x20003CE0
CC1312_L210026N.coml = # CC1312_L2100238.coml				
asic				10 C
General Setup		Advanced Setup		
This section describes the general configuration about the target.				
Connection Texas Instruments XDS110 USB Debug Probe	~	Target Configuration: lists the configuration op	ptions for the target.	
Board or Device type filter text		Save Configuration		
CC1310F128 CC1310F32 CC1310F64	^	Save		
CC13128H93 CC1350F128 CC1350F128 CC1352P1F3		Text Connection To text a connection, all changes must have be configuration file contains no errors and the co Text Connection		
CC3528FF3 CC2620F128 CC2630F128		Alternate Communication		
CC2640F128	~	Uart Communication ~ To enable host side (i.e. PC) configuration nece		
CC2640R2F		communication over UART, target application	in TI Resource Explorer. If your	
	xcu ^	target application leverages 11-870S, then pley enable Uart Monitor module.	se check documentation on how to	
CC364082F     Next generation CC1310 device, the SimpleLink(IM) Sub-1 GHz CC1312 winners 8     lister: Support for more devices may be available from the update manager.	KOU Ú	target application leverages TI-RTOS, then plea		
COMMUT           Red generation CC1110 device, the Simplicite(TM) Sub-1 Get CC1112 winders N           Note: Support for more devices may be available from the update manager.           ad/ Manaced Source;	v	target application leverages 11 4005, then plex enable Uast Monitor module. To add a port in the target application for Uan	Monitor, dick the Add button.	- B +
COSHIDI     Net generation CC3102 device, the SimpleDevice(TM) Sub-1 Get: CC3122 wireless to     Note: Support for more devices may be available from the update manager.     Excit Advanced Source     Consule II	v	target application leverages 11 #805, then ples enable Uart Monitor module. To add a port in the target application for Uart	Monitor, dick the Add button.	187.1
CC264082F	v	target application leverages 11 4005, then plex enable Uast Monitor module. To add a port in the target application for Uan	Monitor, dick the Add button.	- 8 -

### 图 12. Code Composer Studio™ Debug: Running Software in Debug Mode



 $\frac{1}{8}$  8 summarizes some global variables to debug the software example.

VARIABLES	DESCRIPTION
TCPIP_Dbg	Debug counts for UDP, IPv6, ICMPv6, RPL layers
LOWPAN_Dbg	Debug counts for 6LoWPAN layer
devInfoBlock	Device state machine and PAN information
mwDbg	Debug counts for middleware layer
macPib	TI-15.4 MAC PIB
FHPIB_db	TI-15.4 FH MAC PIB
joinedDODAG	Flag to indicate RPL DODAG join state
ApiMac_extAddr	8B extended MAC address

#### 表 8. Global Variables for Debugging

#### 3.1.2.2.3.2 Sniffer Setup

A sniffer can be used to read the code with Wireshark<sup>™</sup>. This is useful for debugging purposes such as encryption verification. This sniffer will require use of an extra CC13x2R LaunchPad configured as a sniffer and connected to a computer to log the packets.

Install and set up SmartRF Protocol Packet Sniffer 2 using the SmartRF Packet Sniffer 2 User's Guide.

The software must be configured correctly to facilitate the packet reception. The sniffing process may present challenges because this design uses frequency hopping, and the frequency that must be sniffed often changes. To avoid such complications, the TIDA-010024 software can be configured with the frequency hopping mode of using a single channel.

In the file Application/subg/config.h, use the following code to configure the software as one channel communication:

/\*! Use only one channel for sniffing purpose \*/
#define SINGLE\_FH\_CHANNEL

Once the software is configured and compiled, launch Wireshark to start sniffing as shown in 图 13.

. σ × 
 aptaining from vyagerowne, over

 Edit View Go Capture Analyze Statistics Telephony Wireless Tools

 Z
 Image: Statistic Statistics Telephony Wireless Tools
 - • Eq Legd: 140 137 Data, Src: 00:12:40:00:18:94:0f:05, Data Frame 137 Data, Src: 00:12:40:00:18:48:55:00, Data Frame 137 Data, Src: 00:12:40:00:18:48:59:40; Data Frame 137 Data, Src: 00:12:40:00:18:48:59:40; Data Frame 137 Data, Src: 00:12:40:00:18:48:59:40; Data Frame 136 Data, Src: 00:12:40:00:18:48:57:40; Data Frame 136 Data, Data Src: 00:12:40:00:18:48:57:40; Data Src: 00:12:40:00:18:48:55:40; Data Frame 136 Data, Src: 00:12:40:00:18:48:57:40; Data Src: 00:12:40:00:18:48:55:40; Data Frame 136 Data, Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:55:40; Data Frame 136 Ada, Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:57:40; AdX Frame 137 Ada, Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:57:40; AdX Frame 137 Ada, Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:15:40; AdX Frame 138 Ada, Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:15:40; AdX Frame 138 Ada; Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:15:40; AdX Frame 139 Ada; Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:15:40; AdX Frame 131 Ada; Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:15:40; AdX Frame 131 Ada; Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:15:40; AdX Frame 131 Ada; Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:15:40; AdX Frame 134 Ada; Data Src: 00:12:40:00:18:48:57:40; Src: 00:12:40:00:18:48:57:40; AdX Frame 134 Ada; Data Src: 00:12:40; AdX Frame 134 Ada Destination Time 5 48.496882 5 48.537292 7 120.737753 8 120.778108 Protocol TI 802.15.4GE TI 802.15.4GE TI 802.15.4GE TI 802.15.4GE 00:12:4b:00:18:9a:df:05 00:12:4b:00:18:a8:5c:d0 00:12:4b:00:18:a8:74:ac 00:12:4b:00:18:a8:59:3c 
 8
 120, 797188
 00:12:40:00:15:saf:sig:de:db

 9
 120, 80554
 00:12:40:00:15:saf:scf:dc

 120, 86529
 00:12:40:00:15:saf:scf:dc
 00:00:12:40:00:15:saf:scf:dc

 120, 86529
 00:12:40:00:15:saf:scf:dc
 00:12:40:00:15:saf:scf:dc

 120, 863954
 00:12:40:00:15:saf:scf:dc
 00:12:40:00:15:saf:scf:dc

 120, 863954
 00:12:40:00:15:saf:scf:dc
 00:12:40:00:15:saf:scf:dc

 120, 120;945
 00:12:40:00:15:saf:scf:dc
 00:12:40:00:16:saf:scf:dc

 120, 120;945
 00:12:40:00:15:saf:scf:dc
 00:12:40:00:16:saf:scf:dc

 140;250, 163951
 00:12:40:00:15:saf:scf:dc
 00:12:40:00:16:saf:scf:dc
 TI 802.15.46E 
 Internet Protocol, Version 4, 5c: 192:148.1.3, Det: 192.168.1.3

 Enternet Protocol, Sc: Port: 17760, Det: 192.168.1.3

 It Bez, SA 662 SUM Protocol, Sc: Port: 17760, Det: 197.60

 TB addo Factet Info

 TB 80.256.402 SUM Protocol, Sc: Port: 17760, Det: Port: 17760

 It Bez, SA 662 SUM Protocol, Sc: Port: 17760, Det: Port: 17760

 TB 80.256.402 SUM Protocol, Sc: Port: 17760, Det: Port: 17760

 It Bez, SA 662 SUM Protocol, Sc: Port: 17760, Det: Port: 17760, Det: 17760, Det: 1787, Det: Port: Port: Port: Port: Port: 1760, Det: 1787, Det: 17 Z Length (data.len) Packets: 14 · Displayed: 14 (100.0%) Profile: Default

#### 图 13. Wireshark™ Sniffer Window

ZHCU570A-October 2018-Revised March 2019



#### 3.1.2.2.3.3 ROV Analysis

CCS provides a useful tool to debug the software, RTOS Object View (ROV). The ROV tool helps to address various software crash issues or to optimize software examples by analyzing peak memory usage. To debug software with the ROV tool:

- 1. Suspend debug mode and open ROV as shown in 🖄 14. 🕅 15 shows the screen capture of ROV (on the right-bottom).
- 2. As an example, go to the *Detailed* and *CallStacks* taps in the *Task* menu to optimize the stack size, to trace the call stacks, or to address the stack overflow issue.

File Edit View Project Tools Pa Memory Map	256-DD*-C*- *- X0 5- B D *-						Quick Access	l et a W
GEL Files							x & # (C) et	
On-Chip Flash		** Variables ** Expressions ** ** Registers		COM SI .	* # #   D B			
ARM Advanced Features	Composer Studio - Device Debugging]	Expression	Type	Value	Address			
Debugger Options	B Debug Probe_0/Contex_M4_0 (Suspended) > HF134	> 💣 mwDbg	struct <unnamed></unnamed>	jcntRandZero=0 "u00".kaRaTimeOut=2 "u02".ontKaRuInd0x200033				
	y) at PowerCC26X2_tirtos.c157 0x00013CAA	> @ TCPIP_Dbg	struct_trpip_debug	htpip_tmout_ont=0.tcpip_tmout_post_err=0.tcpip_input_				
Save Memory	26502.c241 0x0001E406	> @LOWPAN_Dbg > @devtn/oBlock	struct <unnamed> struct <unnamed></unnamed></unnamed>	[total_rx_packet=3364.buf_full_drop_segment=0.frag_n_h. [panID=4660.coordExtAddr=[193 'uc1'.87 'W.168 'us8'.				
Load Memory	re defined)	all macPib	struct curnamed>	(aciWaitDuration=54 '6',associationPermit=0 'y00',auto				
Fill Memory		P FHPR db	struct cumamed>	(macTrackParentEU1+(202 1aca) 114 Y.168 1xall 24 1x18.				
& ROV Classic		= joinedDODAG	unsigned char	1 'u01'	0x20003228			
Runtime Object View		> @ ApiMac extAddr	unsigned char[8]	[5 "x05".223 "xell".154 "x9a".24 "x18".0 "x00"]	0x20003CE0			
🖬 Hardware Trace Analyzer		Add new expression		b becker becker besk besk				
System Analyzer								
KTOS Analyzer								
EnergyTrace <sup>**</sup>								
Li Graph	>							
Image Analyzer								
Profile	>							
R CC1312_L210026N.coml = R C	C1312 12100238.com							· 0
Basic								<b>H</b> D <b>^</b>
								10.0
General Setup			Advanced Setup					
This section describes the general								
Connection Texas Instrumen	vts XDS110 US8 Debug Probe	w.	Target Configuration: lists the configuration options for	the target.				
Basic Advanced Source								
8 Target Configurations 11							5.8	
type filter text								
Projects								~
a User Defined								
& CC1312_L21000DR.com/								
# CC1312_L21000GA.com/								
8 CC1312_L21000HL.com								
B CC1312_L210000.com								
# CC1312_L21000I1.com								
# CC1312_L21000LL.coml # CC1312_L21000LR.coml								
8 CC1312 L2100214.com								
< CC1312_L210021H.comi								
# CC1312 L210021U.com								
# CC1312 L2100238.ccxml	(Default)							
# CC1312_L210025X.coml								
8 CC1312_L210026D.com								
K CC1312_L210026E.coml								
8 CC1312_L210026F.coml								
E CC1312_L210026N.comi								
R CC1312 1210026P.coml								Ŷ
Click the New button to create a ne	w target configuration file. Click here to hide this message.							
				0				LE

#### 图 14. Code Composer Studio™ Debug: Launch ROV

图 15. Code Composer Studio<sup>™</sup> Debug: Debug Software With ROV Tool

le 66 Veze Peiget Tools Run Sogts Wedow Help 3 = (0   0   0   0 = 0 = 3 < 0 < 0   0 = 0 = 3 < 0 < 0 = 0 = 0 < 0 < 0 < 0 < 0 < 0 < 0	<b></b> بر ا												
Debug II     • 0 CC1312, L210021H.com/ [Code Composer Studio - Device Debugging]     • ✓ Texas Instruments XDS110 USB Debug Probe, 0/Cortex, M4, 0 (Suspended)												Quick Acces	
<ul> <li>© CC1312_L210021H.comi [Code Composer Studio - Device Debugging]</li> <li></li></ul>	8												
* # Texas Instruments XDS110 US8 Debug Probe_0/Contex_M4_0 (Suspended)		0 10 M	riables 🛠	Expression	5 II III I	Registers					0.000	× 월 🖉 🖸 🖻	1.49
			ession					Type	Value	Address			
			mwDbg					struct <unnamed></unnamed>	(cntRandZero=0 %00/.kaRxTimeOut=2 %02/.ontKa				
CPUwfi() at cpu/h215 0x0001F134			TCPIP_Dbg					struct_trpip_debug	(tcpip_tmout_cnt=0.tcpip_tmout_post_err=0.tcpip_)				
PowerCC2002_standbyPole(s) at PowerCC2002_stins.c157 0x00013CAA     Power jdfefunc) at PowerC22002.c241 0x00018406     Ont0038226 ino symbols are defined:			LOWPAN,					struct <unnamed></unnamed>	(total_rx_packet=3364,buf_full_drop_segment=0,fra				
			devinio8k	xck				struct «unnamed»	[panID+4660.coordExtAddr+[193 '\xc1',87 'W',168				
<ul> <li>0x10036226 (no symbols are denied)</li> </ul>			macPib FHPIB_db					struct <unnamed></unnamed>	(ackWaitDuration=54 '6',associationPermit=0 '\u00',				
			FHPI8_db ioinedDOI					struct <unnamed></unnamed>	(macTrackParentEUI=(202 'uca',114 'r',168 'ucal',24 1 'u01'	%18 0x20002900 0x20003228			
			ApiMac en					unsigned char	[5 'xx05'.223 'xx8P'.154 'xx9a'.24 'xx18'.0 'xx00']	0x20003228			
			Add new e					unsigned char[8]	[5 \u05,223 \u07,154 \u07,154 \u07,24 \u18,0 \u00]	0x20003CE0			
			Add new e	opression									
Target Configurations III RIOS Object View (ROV) H	A Basic M	dan da da a	and the Ba										
# 6lowpan_t5_15_4_cc13x2.out					h and	la Milana	er curltrigger						
* @ Viewable Modules	0x200			5_ 0.0			o or myger						
<ul> <li>BIOS</li> </ul>	0x200			A_ 0x2			0						
Clock	0x200			R_ 0.0			0						
Diags	0x200_			R. 0x0			0						
Event	0x200			PL_ 0x0			0						
Gatelfeel													
<ul> <li>GateMutex</li> </ul>													
HeapMern													
HeapMin													
• Hui													
• Idle													
Maibox													
Queue													
<ul> <li>Registry</li> </ul>													
<ul> <li>Semaphore</li> </ul>													
Startup													
Startup     Swi													
• Starh.p • Sei • System													
• Sartup • Ş <b>wi</b> • Şıyıtam • Şak													
# Startup # Sant # System # Task # Task													
• Startup • <b>Swi</b> • System • Eask													

#### Hardware, Software, Testing Requirements, and Test Results

### 3.2 Testing and Results

#### 3.2.1 Test Setup

 $\overline{x}$  9 summarizes the CCS build configuration to set up the end nodes and data collector. For these experiments, the end nodes and the data collector use the CC1312R LaunchPad as shown in  $\overline{7}$  3.1.1. The pre-built binaries are provided in the reference design software package.

DEVICE	BUILD CONFIGURATION	NOTE
END NODE	<ul><li> debug_poll</li><li> debug_poll_dtls</li></ul>	_dtls configuration was used for DTLS verification shown in 3.2
DATA COLLECTOR	<ul><li>debug_root_poll</li><li>debug_root_poll_dtls</li></ul>	

#### 表 9. Firmware for Test Setup

#### 3.2.1.1 Creating Multi-hop Topology

It is challenging to create multi-hop networks in a small LAB area. For the experiments, the multi-hop topology was created with address filtering in the software. Each node has a list of entries where the node can accept the packet reception. To create a linear multi-hop topology, each node maintains two entries: one is the target parent and one is the target child.

```
#define NUM_ENTRIES 2 //Address filter to create multi-hop topology
//entry #0: target parent, entry #1: target child
//{0xBB, 0x63, 0xA4, 0x13, 0x00, 0x4B, 0x12, 0x00} (hop-1)
uint8_t whitelist[NUM_ENTRIES][8]={
{0x91, 0xC7, 0x27, 0x0A, 0x00, 0x4B, 0x12, 0x00},
{0x70, 0x63, 0xA4, 0x13, 0x00, 0x4B, 0x12, 0x00} };
```

In the software, this feature can be enabled with the "CONFIG\_MULTIHOP\_TESTING" macro defined in /Application/subg/config.h.

注: For testing setup, modify the list of entries defined in /Application/middleware.c based on the extended address of the test node. For each node, the extended address set at the initial stage is stored in the global variable of "ApiMac\_extAddr".

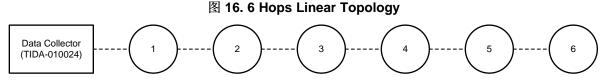
The multi-hop network with the address filtering technique has pros and cons in terms of network performance because a node can communicate with a dedicated set of nodes only while all of the nodes can be seen with each other. A disadvantage is that a node limits the path diversity over multi-hop topology while an advantage is that this setup can avoid hidden node problems.

#### 3.2.2 Improved Security Performance

The goal of this experiment is to validate the security functionality implemented in the TIDA-010024 reference design. With DTLS, the TIDA-010024 offers a secured transmission mechanism of using a different private key per link.

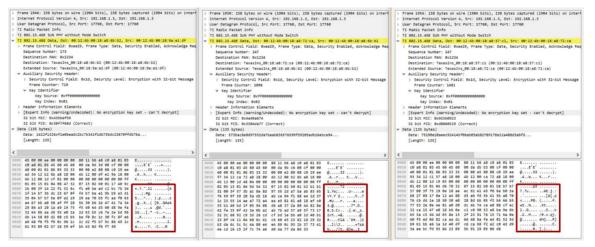
To verify if the encryption works correctly, a packet sniffer was used to read the encrypted messages. To set up the packet sniffer, follow the instructions described in  $\ddagger$  3.1.2.2.3.2. This experiment was performed with the UDP poll example and uses over a 6-hop linear topology as shown 🛽 16.





To test the encryption, a message is sent from node 6 to the data collector by passing through every node. The sniffer shows the data transfer between each of the nodes. At each hop, the message is decrypted and then re-encrypted with the private key shared for each link-level connection. 图 17 shows the same message captured at different hops.





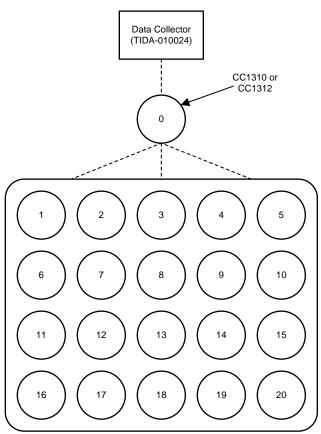
In 🕅 17, the same data is sent between neighbors, but the value intercepted by the sniffer is different because the same data is encrypted with different keys. This mechanism makes this network more robust against tampering.

#### 3.2.3 Impact of Network Capacity on Performance: An Example of the Bottleneck Scenario

The goal of this experiment is to validate the impact of increased routing capacity on the network performance in a bottleneck scenario. Compared to CC1310, the CC1312R has more memory to support bigger neighbor and routing entries.

For this experiment, the UDP poll example is used over a bottleneck scenario where all the data goes through a single router (node 0) as shown in 🕅 18. A data collector sends a 100B poll message every 5 seconds and, as a response, each node sends back the same size data packet to the data collector.





#### 图 18. A Bottleneck Scenario

This experiment was done with the CC1310 and the CC1312 at the bottleneck location of node 0. With the CC1312R, the data collector can reach at every node without losing connections due to the increased capacity.

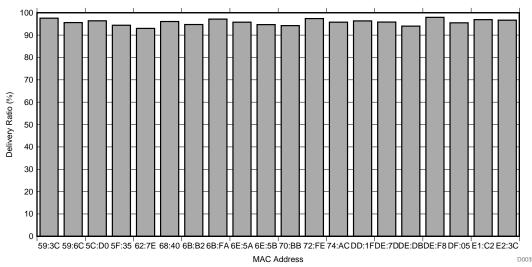


图 19. Delivery Ratio Performance With CC1312R Over a Bottleneck Scenario

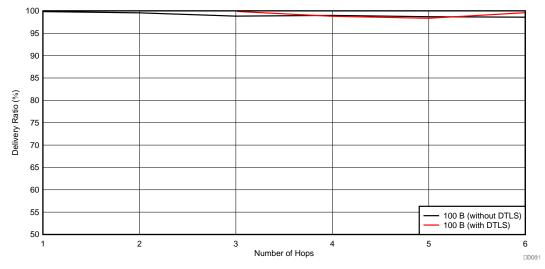
19 shows delivery ratio performance with CC1312R over the bottleneck scenario. The x-axis shows MAC address of each node and the y-axis is delivery ratio performance in percentage. The experimental result shows that the average delivery ratio achieves 95.75%.



The same experiment was performed by replacing CC1312R with CC1310 for node 0. The result shows that, as expected, with CC1310 the overall network performance is degraded due to network instability caused by the limited capacity.

#### 3.2.4 Impact of DTLS Security on Network Performance

It is important to ensure that the DTLS overhead does not degrade the network performance. To validate the impact of overhead on system performance, the round-trip time and delivery ratio were measured with and without DTLS over a 6-hop linear topology.



#### 图 20. Delivery Ratio Comparison With and Without DTLS

20 shows the delivery ratio performance with and without DTLS. The experiment ran for a day. The experimental result shows that both achieve similar delivery ratio performance regardless of the number of hops. Without DTLS, the average delivery ratio achieves 99.08% and with DTLS, the delivery ratio is 99.42%.

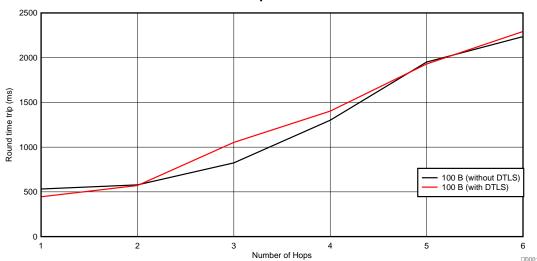


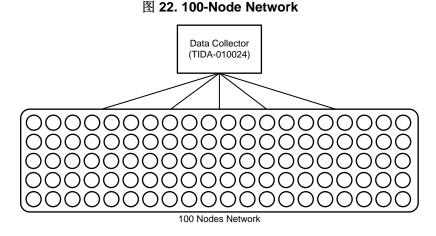
图 21. Round Time Trip With and Without DTLS

In 21, with the same experiment, the average round-trip time was measured. For a six-hop distance, the round-trip time performance shows 2.294 seconds with DTLS and 2.236 seconds without DTLS.

In conclusion, the experimental results show that the impact of the DTLS overhead on network performance is negligible. This is because the simplified 2-way DTLS handshaking mechanism reduces the impact of the DTLS overhead on network performance and the transaction happens one time at the beginning.

#### 3.2.5 100-Node Network Testing

The goal of this experiment is to measure delivery ratio performance as well as to verify the software reliability in a large network. For the experiment, the UDP poll with DTLS example was used. The data collector polls each node every 10 seconds with 100B of data. 🛛 22 shows the topology of the network used for this experiment.

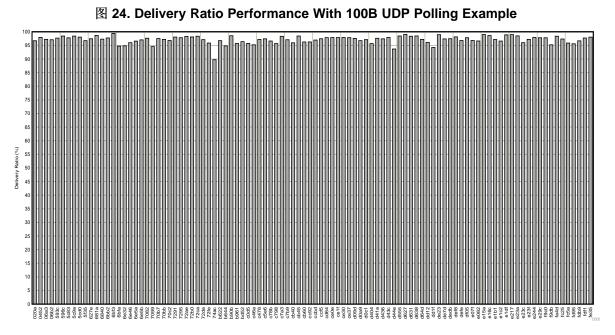


This experiment runs for 3 days to collect enough data. A CC1312R LaunchPad was used as data collector and the 100 LaunchPads shown in 🕅 23 are 50 CC1312R LaunchPads and 50 CC1352R LaunchPads.

#### 图 23. 100-Node Network Test Setup







 $\frac{10}{10}$  summarizes test cases to verify the software reliability and self-healing feature with the 100-node network setup. The experiments use the UDP polling example with 100B of data. The experimental results show that the 6LoWPAN mesh software works reliably without losing connections in the 100-node setup, and the keep-alive mechanism implemented in the software is functional by detecting and recovering connection losses.

TEST CASE	DESCRIPTION	PASS or FAIL
Long-run data testing (> 3 days)	Run 100B UDP polling example in the 100-node setup	Pass (All 100 nodes stayed connection to the data collector)
Self-healing testing (data collector failure)	Power-cycle the data collector to see if all the 100 nodes are reconnected to the network.	Pass
Self-healing testing (end-node failure)	Power-cycle some end-nodes to see if all the 100 nodes are reconnected to the network.	Pass

#### 表 10. Software Reliability Test Summary



#### 4 Design Files

#### 4.1 Schematics

To download the schematics, see the design files at TIDA-010024.

#### 4.2 Bill of Materials

To download the bill of materials (BOM), see the design files at TIDA-010024.

#### 4.3 PCB Layout Recommendations

#### 4.3.1 Layout Prints

To download the layer plots, see the design files at TIDA-010024.

#### 4.4 Altium Project

To download the Altium Designer® project files, see the design files at TIDA-010024.

#### 4.5 Gerber Files

To download the Gerber files, see the design files at TIDA-010024.

#### 4.6 Assembly Drawings

To download the assembly drawings, see the design files at TIDA-010024.

#### 5 Software Files

To download the software files, see the design files at TIDA-010024.



#### Related Documentation

#### 6 Related Documentation

- 1. Texas Instruments, Simple 6LoWPAN Mesh End-Node Improves Network Performance Reference Design
- 2. Texas Instruments, Simple 6LoWPAN Mesh Data Collector Improves Network Performance Reference Design
- 3. Texas Instruments, Universal data concentrator reference design supporting Ethernet, 6LoWPAN RF mesh and more
- 4. Texas Instruments, SmartRF Packet Sniffer 2 v1.5.0 User's Guide

#### 6.1 商标

SimpleLink, E2E, Code Composer Studio are trademarks of Texas Instruments. Altium Designer is a registered trademark of Altium LLC or its affiliated companies. Arm, Cortex are registered trademarks of Arm Limited. Wireshark is a trademark of Wireshark Foundation, Inc. All other trademarks are the property of their respective owners.

#### 6.2 Third-Party Products Disclaimer

TI'S PUBLICATION OF INFORMATION REGARDING THIRD-PARTY PRODUCTS OR SERVICES DOES NOT CONSTITUTE AN ENDORSEMENT REGARDING THE SUITABILITY OF SUCH PRODUCTS OR SERVICES OR A WARRANTY, REPRESENTATION OR ENDORSEMENT OF SUCH PRODUCTS OR SERVICES, EITHER ALONE OR IN COMBINATION WITH ANY TI PRODUCT OR SERVICE.

#### 7 About the Author

**WONSOO KIM** is a system engineer at Texas Instruments, where he is responsible for driving grid communication system solutions, defining future requirements in TI product roadmap, and providing system-level support and training focusing on communication systems for Smart Grid customers. He received a Ph.D. degree in electrical and computer engineering from the University of Texas, Austin, Texas.

**MICKAEL CHOUTEAU** is a field application engineer at Texas Instruments, where he is responsible for technical support for industrial customers. His design experience covers both hardware design (signal chain, battery monitoring) and software design (low level drivers, RTOS, and RF protocols). He received a master degree in embedded system engineering from ECE Paris University in France.

TEXAS INSTRUMENTS

Page

### 修订历史记录

#### 注: 之前版本的页码可能与当前版本有所不同。

Changes from Original (October 2018) to A Revision

•	已添加 向 特性 部分中添加了列表项	. 1
•	己删除 从 应用 部分中删除了街道照明	. 1
•	已添加 向 应用 部分中添加了水表和燃气表	. 1
•	已更改 information regarding what is supported by TI SimpleLink PHY	. 2
•	已更改 information and values in the System Features of TIDA-010024 and TIDA-010003 table	. 2
•	已更改 the TIDA-010024 System Architecture image	. 3
•	已更改 information and values in the Key System Specifications table	. 4
•	已更改 CC1312 to CC1312R throughout document	
•	已删除 information regarding the CC1352EVM from the Hardware section	. 9
•	已更改 title of the Build Configurations of TIDA-010024 table to CCS Build Configurations	10
•	已更改 information in the CCS Build Configurations table	
•	已更改 Code Composer Studio XDC Tool and SDK Versions image	12
•	已更改 title of the 6LoWPAN_TI_15_4_Example section to 6LoWPAN Mesh TI 15.4 Example	13
•	已更改 title of the DTLS Data Encryption section to DTLS Encryption	
•	已更改 information in the DTLS Encryption section	15
•	已更改 sensor_cc13x2r1lp to sensor_cc1312r1lp	16
•	已更改 SimpleLink CC13x2 SDK v2.10.00.48 to SimpleLink CC13x2 and CC26x2 SDK v2.40	16
•	已更改 information in the Firmware for Test Setup table	23
•	已更改 title of Creating Multi-hop Linear Topology section to Creating Multi-hop Topology	23
•	已更改 information in the Improved Security Performance section	23
•	已更改 title of the Improved Security Performance section to Impact of Network Capacity on Performance: An Example	of
		24
•	已更改 information in the Impact of Network Capacity on Performance: An Example of the Bottleneck Scenario section	
•	已更改 title of the Bottleneck Scenario With CC1312 Delivery Ratio image to Delivery Ratio Performance With CC1312	
	Over a Bottleneck Scenario	
•	已更改 information in the Impact of DTLS Security on Network Performance section	
•	已更改 information in the 100-Node Network Testing section	
•	已更改 title of the 100 Nodes Network image to 100-Node Network	
•	已更改 title of the 100 Nodes Network Test Setup image to 100-Node Network Test Setup	
•	已添加 Wonsoo Kim to About the Author section	30

#### 重要声明和免责声明

TI"按原样"提供技术和可靠性数据(包括数据表)、设计资源(包括参考设计)、应用或其他设计建议、网络工具、安全信息和其他资源, 不保证没有瑕疵且不做出任何明示或暗示的担保,包括但不限于对适销性、某特定用途方面的适用性或不侵犯任何第三方知识产权的暗示担 保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任:(1) 针对您的应用选择合适的 TI 产品,(2) 设计、验 证并测试您的应用,(3) 确保您的应用满足相应标准以及任何其他功能安全、信息安全、监管或其他要求。

这些资源如有变更,恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的应用。严禁对这些资源进行其他复制或展示。 您无权使用任何其他 TI 知识产权或任何第三方知识产权。您应全额赔偿因在这些资源的使用中对 TI 及其代表造成的任何索赔、损害、成 本、损失和债务,TI 对此概不负责。

TI 提供的产品受 TI 的销售条款或 ti.com 上其他适用条款/TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

邮寄地址:Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022,德州仪器 (TI) 公司